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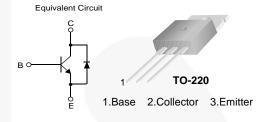
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# KSC5603D NPN Silicon Transistor, Planar Silicon Transistor

#### **Features**

- High Voltage High Speed Power Switch Application
- Wide Safe Operating Area
- Built-in Free Wheeling Diode
- Suitable for Electronic Ballast Application
- Small Variance in Storage Time



#### **Ordering Information**

Part Number	Marking	Package	Packing Method
KSC5603DTU	C5603D	TO-220 3L	Rail

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	1600	V
V <sub>CEO</sub>	Collector-Emitter Voltage	800	V
V <sub>EBO</sub>	Emitter-Base Voltage	12	V
۱ <sub>C</sub>	Collector Current (DC)	3	А
I <sub>CP</sub>	Collector Current (Pulse) <sup>(1)</sup>	6	А
I <sub>B</sub>	Base Current (DC)	2	А
I <sub>BP</sub>	Base Current (Pulse) <sup>(1)</sup>	4	А
P <sub>C</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )	100	W
ТJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C

#### Notes:

1. Pulse test: pulse width = 5 ms, duty cycle  $\leq 10\%$ 

### **Thermal Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Paran	neter	Rating	Unit
R <sub>θJC</sub>	Thermal Resistance	Junction-to-Case	1.25	°C/W
R <sub>θJA</sub>	Thermal Resistance	Junction-to-Ambient	80	°C/W
TL	Maximun Lead Temperatur : 1/8" from Case for 5 secor	•	270	°C

#### **Electrical Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

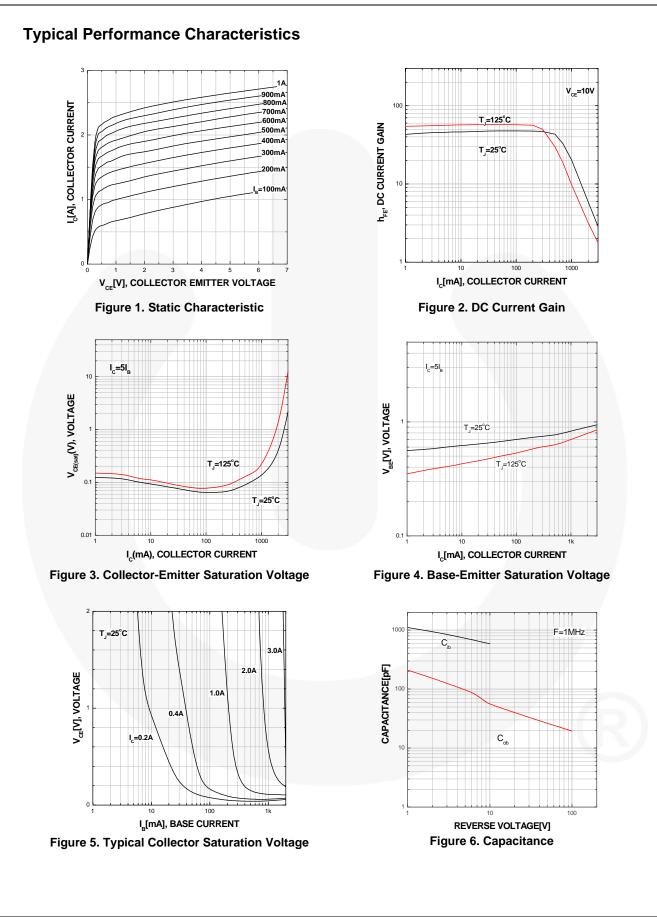
Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_{\rm C} = 0.5 \text{ mA}, I_{\rm E} = 0$		1600	1689		V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 5$ mA, $I_{\rm B} = 0$		800	870		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = 0.5 mA, I <sub>C</sub> = 0		12.0	14.8		V
10-0	Collector Cut-Off Current	V <sub>CE</sub> = 1600 V, V <sub>BE</sub> = 0	$T_A = 25^{\circ}C$		0.01	100	μA
ICES		$v_{CE} = 1000 v, v_{BE} = 0$	T <sub>A</sub> = 125°C			1000	
lana	Collector Cut-Off Current	$V_{CE} = 800 \text{ V}, I_B = 0$	$T_A = 25^{\circ}C$		0.01	100	μA
I <sub>CEO</sub>			T <sub>A</sub> = 125°C			1000	
I <sub>EBO</sub>	Emitter Cut-Off Current	$V_{EB} = 12 \text{ V}, \text{ I}_{C} = 0$			0.05	500	μΑ
h <sub>FE</sub> C	DC Current Gain	$V_{CE} = 3 \text{ V}, I_{C} = 0.4 \text{ A}$	T <sub>A</sub> = 25°C	20	29	35	
			T <sub>A</sub> = 125°C	6	15		
		$V_{0r} = 10 V I_0 = 5 mA$	T <sub>A</sub> = 25°C	20	43		
			T <sub>A</sub> = 125°C	20	46		
		I <sub>C</sub> = 250 mA, I <sub>B</sub> = 25 mA			0.50	1.25	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA			1.50	2.50	V
	Vollago	I <sub>C</sub> = 1 A, I <sub>B</sub> = 0.2 A			1.20	2.50	
	Base-Emitter Saturation Voltage	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA	$T_A = 25^{\circ}C$		0.74	1.20	
V (oot)			T <sub>A</sub> = 125°C		0.61	1.10	V
V <sub>BE</sub> (sat)		$I_{\rm C} = 2 \text{ A}, I_{\rm B} = 0.4 \text{ A}$	T <sub>A</sub> = 25°C		0.85	1.20	
		$T_{\rm C} = 2$ A, $T_{\rm B} = 0.4$ A $T_{\rm A} = 125^{\circ}{\rm C}$			0.74	1.10	
C <sub>ib</sub>	Input Capacitance	V <sub>EB</sub> = 10 V, I <sub>C</sub> = 0, f = 1 MHz			745	1000	pF
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MHz			56	500	pF
f <sub>T</sub>	Current Gain Bandwidth Product	I <sub>C</sub> = 0.1 A,V <sub>CE</sub> = 10 V			5		MHz
V	Diada Farward Valtage	I <sub>F</sub> = 0.4 A			0.76	1.20	V
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> = 1 A			0.83	1.50	V

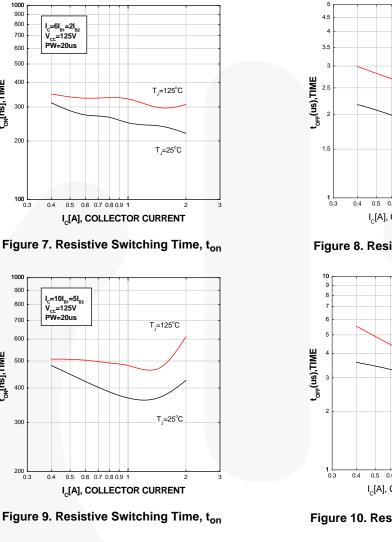
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## Electrical Characteristics (Continued)

Values are at  $T_{\text{A}}$  = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit		
RESISTIVE LOAD SWITCHING (D.C $\leq$ 10%, Pulse Width = 20 µs)								
t <sub>ON</sub>	Turn-On Time	$I_{\rm C} = 0.3 \text{ A}, I_{\rm B1} = 50 \text{ mA},$		400	600	ns		
t <sub>STG</sub>	Storage Time	$I_{B2} = 150 \text{ A}, V_{CC} = 125 \text{ V},$	2.0	2.1	2.3	μs		
t <sub>F</sub>	Fall Time	$R_L = 416 \Omega$		310	1000	ns		
t <sub>ON</sub>	Turn-On Time	$I_{C} = 0.5 \text{ A}, I_{B1} = 50 \text{ mA},$ $I_{B2} = 250 \text{ mA}, V_{CC} = 125 \text{ V},$ $R_{L} = 250 \Omega$		600	1100	ns		
t <sub>STG</sub>	Storage Time			1.3	1.5	μs		
t <sub>F</sub>	Fall Time			180	350	ns		
INDUCTIV	INDUCTIVE LOAD SWITCHING (V <sub>CC</sub> = 15 V)							
t <sub>STG</sub>	Storage Time	$I_{C} = 0.3 \text{ A}, I_{B1} = 50 \text{ mA},$ $I_{B2} = 150 \text{ mA}, V_{Z} = 300 \text{ V},$ $L_{C} = 200 \text{ H}$	0.60	0.73	0.90	μs		
t <sub>F</sub>	Fall Time			170	250	ns		
t <sub>C</sub>	Cross-Over Time			180	250	ns		
t <sub>STG</sub>	Storage Time	$I_{C} = 0.5 \text{ A}, I_{B1} = 50 \text{ mA},$ $I_{B2} = 250 \text{ mA}, V_{Z} = 300 \text{ V},$ $L_{C} = 200 \text{ H}$	0.70	0.84	1.00	μs		
t <sub>F</sub>	Fall Time			140	175	ns		
t <sub>C</sub>	Cross-Over Time			170	200	ns		

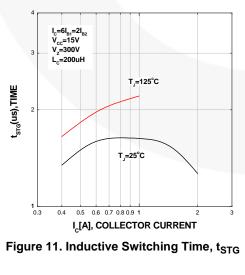




Typical Performance Characteristics (Continued)

t<sub>ov</sub>[ns],TIME

t<sub>ov</sub>[ns],TIME



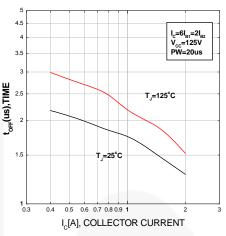


Figure 8. Resistive Switching Time, toff

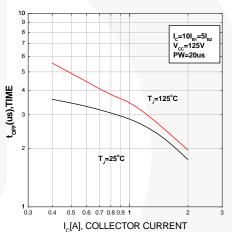
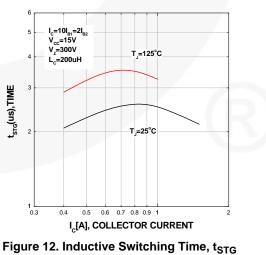
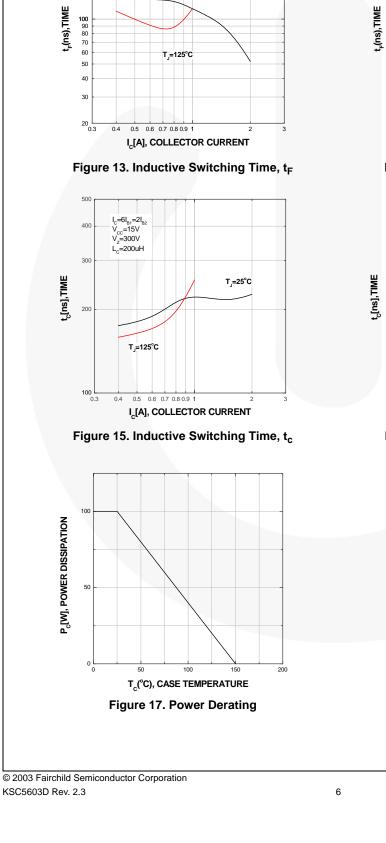


Figure 10. Resistive Switching Time, toff





## Typical Performance Characteristics (Continued)

T\_=25°C

400

300

200

 $I_{c}=6I_{B1}=2I_{B2}$  $V_{cc}=15V$  $V_{z}=300V$ 

\_=200uH

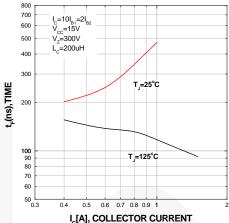


Figure 14. Inductive Switching Time, t<sub>F</sub>

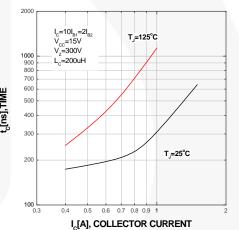


Figure 16. Inductive Switching Time, tc



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